Chip Boxes





Description

Conductive corrugated fibreboard, our chip boxes provide an ESD safe and cost effective method of shipping chips and small electronic devices. They can be provided with soft antistatic foam or high density pin stick grade conductive foam to suit your specific requirement.

Dimensions

Part Number	Length (mm)	Width (mm)	Depth (mm)
027-0020MP	90	30	15
027-0021MP	100	60	15
026-0466MP	120	100	15
027-0035MP	140	40	15
026-0489MP	160	80	15

Important Notice: This data sheet and its contents (the "Information") belong to the members of the AVNET group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp Pro is the registered trademark of Premier Farnell Limited 2019.

Newark.com/multicomp-pro Farnell.com/multicomp-pro sg.element14.com/b/multicomp-pro

